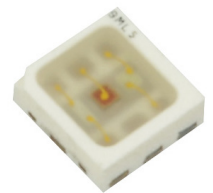
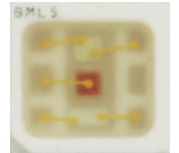


### SpicePlus 2120 Multi Color

Like spice, its diminutive size is a stark contrast to its standout performance in terms of brightness, durability and reliability. Despite being the smallest in size yet the SpiceLED packs a powerful performance and is a highly reliable design device. Its versatility enables its application in automotive appliances, key-pad illumination, hand-held devices such as PDAs, notebooks, compact back-lighting applications, consumer appliances, office equipment, audio and video equipment.



### Features:

- > High brightness surface mount LED.
- > Viewing angle of 120°.
- > Small package outline (LxWxH) of 2.1 x 2.0 x 0.7mm.
- > Qualified according to JEDEC moisture sensitivity Level 2.
- > Compatible to IR reflow soldering.
- > Environmental friendly; RoHS compliance.
- > Superior Corrosion Resistance.
- > LED chips can be controlled separately to display various colors including white.
- > Compliance to automotive standard; AEC-Q102.

### Applications:

- > Automotive: Interior applications, eg: ambient lighting.

**Optical Characteristics at Tj=25°C**

Part Number	Color, $\lambda_{dom}$ (nm)			Luminous Intensity @ If = 20mA IV (mcd) <i>Appx. 1.1</i>		
	Chip #1	Chip #2	Chip #3	Chip #1	Chip #2	Chip #3
SKRTB-MHG-V1V2+W4X4+ST1-1	Red 625nm	True Green 525nm	Blue 455nm	715.0-1125.0	1300.0-2500.0	180.0-355.0
SKRTB-MHG-V1V2+W4X4+R2S-1	Red 625nm	True Green 525nm	Blue 455nm	715.0-1125.0	1300.0-2500.0	140.0-285.0

**Electrical Characteristics at Tj=25°C**

	$V_f$ @ If = 20mA <i>Appx. 3.1</i>			$V_r$ @ Ir = 10uA <i>Appx. 6.1</i>
	Min. (V)	Typ. (V)	Max. (V)	Min. (V)
Red	1.80	2.10	2.40	12
True Green	2.70	3.00	3.30	5
Blue	2.60	2.85	3.10	5

**Absolute Maximum Ratings**

	Maximum Value	Unit
DC forward current (Red / True Green / Blue)	50	mA
Peak pulse current; (Ts = 55°C, tp ≤ 100µs, Duty cycle = 0.03)	200	mA
Reverse voltage <i>Appx. 6.1</i>	Red = 12, True Green / Blue = 5	V
ESD threshold (HBM)	2000	V
LED junction temperature	125	°C
Operating temperature	-40 ... +115	°C
Storage temperature	-40 ... +125	°C
Thermal resistance (single chips on)		
- Real Thermal Resistance		
Junction / solder point, R <sub>th JS real</sub>		
Red	80	K/W
Blue	150	K/W
True Green	160	K/W

**Wavelength Grouping**

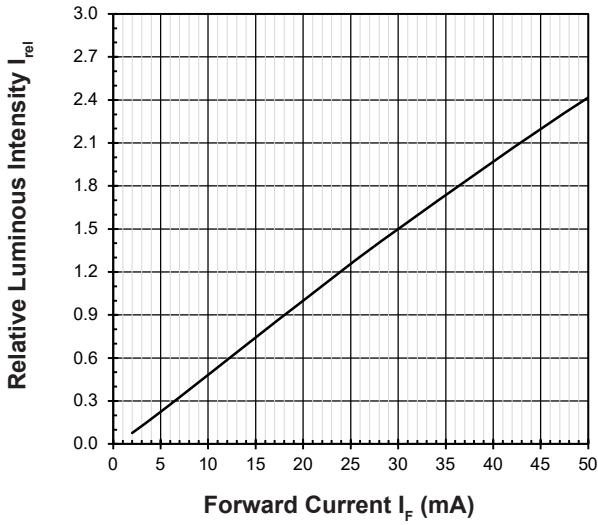
Color	Group	Wavelength distribution (nm) <i>Appx. 2.2</i>
Red	Full	619 - 629
True Green	Full	520 - 535
	A	520 - 525
	B	525 - 530
	C	530 - 535
Blue	Full	450 - 460
	A	450 - 453
	B	453 - 456
	C	456 - 460

**Luminous Intensity Group at Tj=25°C**

Color	Brightness Group	Luminous Intensity <i>Appx. 1.1</i> IV (mcd)
Red	V1	715.0 ... 900.0
	V2	900.0 ... 1125.0
True Green	W4	1300.0 ... 1800.0
	X4	1800.0 ... 2500.0
Blue	R2	140.0 ... 180.0
	S1	180.0 ... 224.0
	S2	224.0 ... 285.0
	T1	285.0 ... 355.0

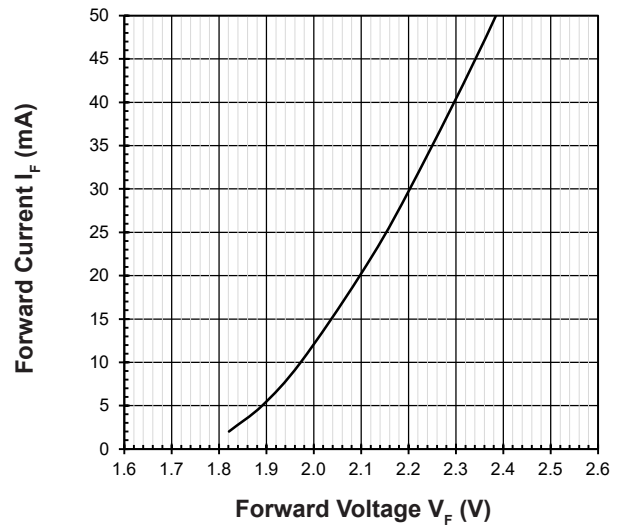
**Relative Luminous Intensity Vs Forward Current**

$I_V/I_V(20mA) = f(I_F); T_j = 25^\circ\text{C}$  (Red)



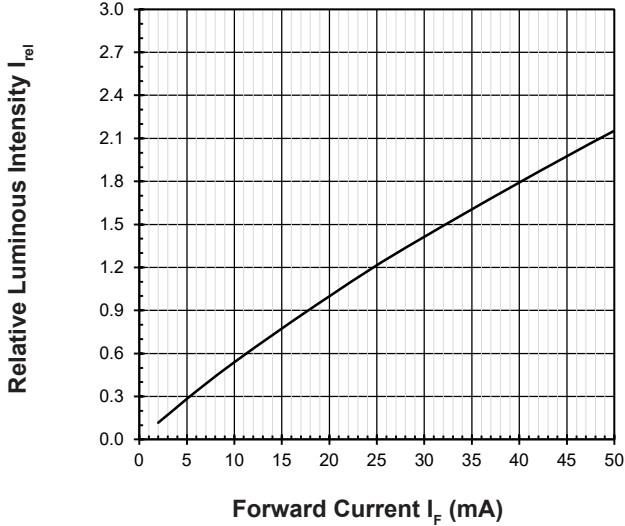
**Forward Current Vs Forward Voltage**

$I_F = f(V_F); T_j = 25^\circ\text{C}$  (Red)



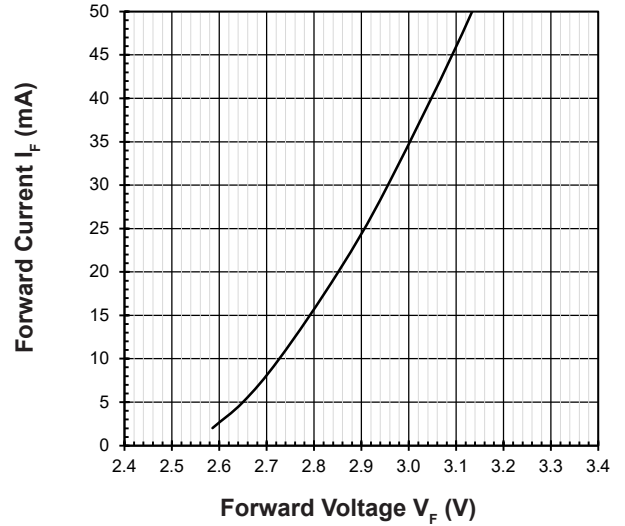
**Relative Luminous Intensity Vs Forward Current**

$I_V/I_V(20mA) = f(I_F); T_j = 25^\circ\text{C}$  (Blue)



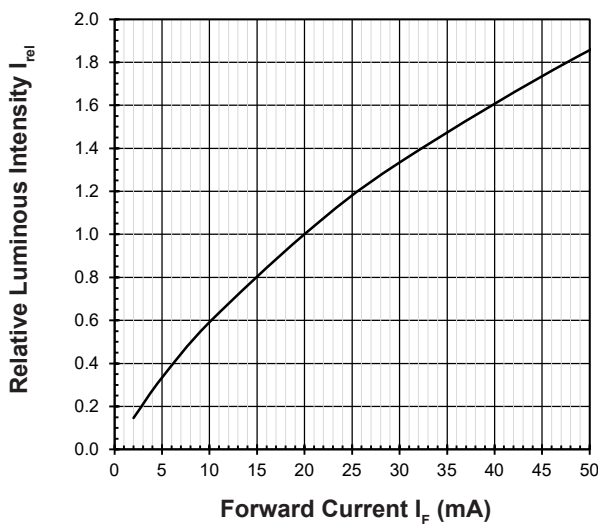
**Forward Current Vs Forward Voltage**

$I_F = f(V_F); T_j = 25^\circ\text{C}$  (Blue)



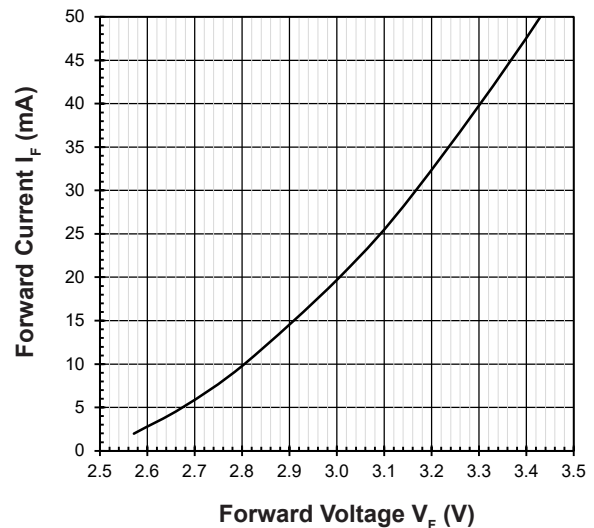
**Relative Luminous Intensity Vs Forward Current**

$I_V/I_V(20mA) = f(I_F); T_j = 25^\circ\text{C}$  (True Green)



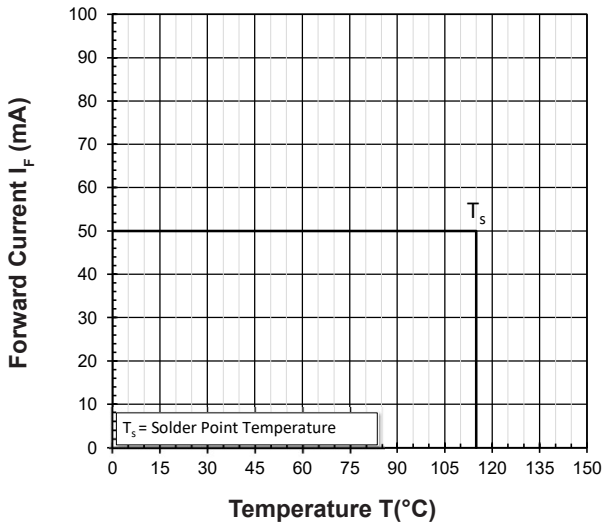
**Forward Current Vs Forward Voltage**

$I_F = f(V_F); T_j = 25^\circ\text{C}$  (True Green)



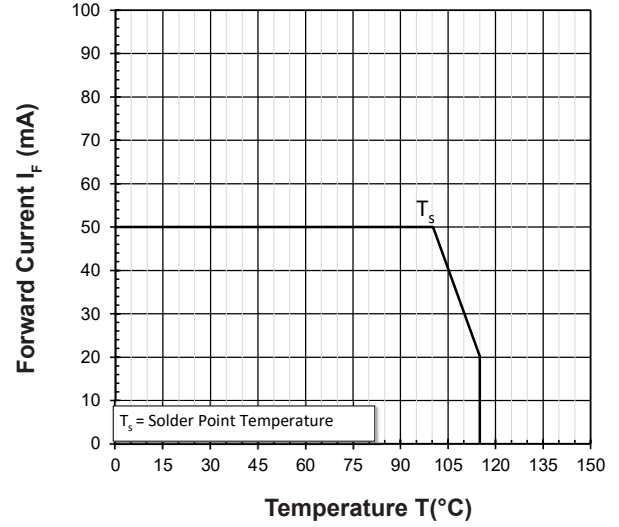
**Maximum Current Vs Temperature**

$I_F=f(T)$  (Red)



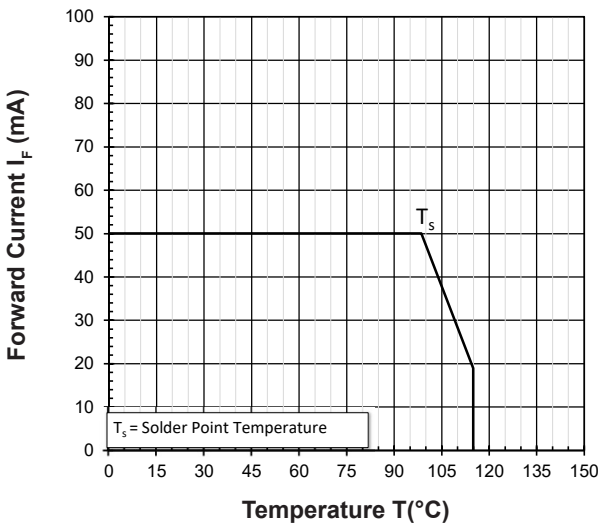
**Maximum Current Vs Temperature**

$I_F=f(T)$  (Blue)



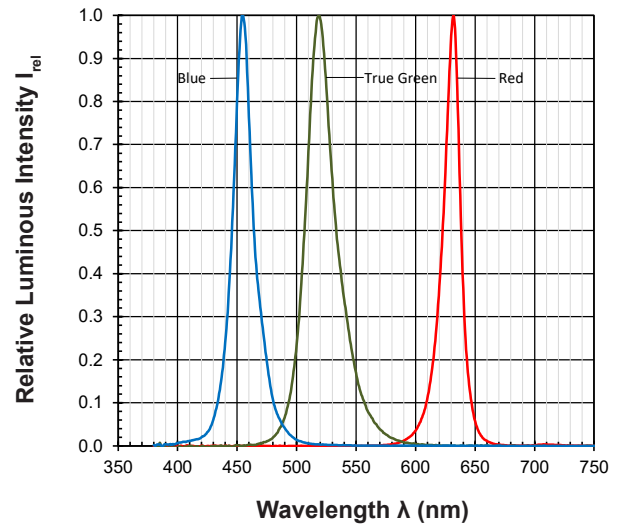
**Maximum Current Vs Temperature**

$I_F=f(T)$  (True Green)



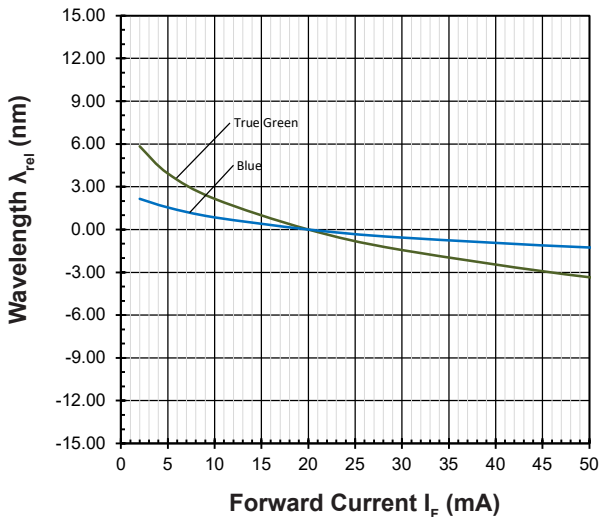
**Relative Spectral Emission**

$I_{rel} = f(\lambda); T_j = 25^\circ\text{C}; I_F = 20\text{mA}$



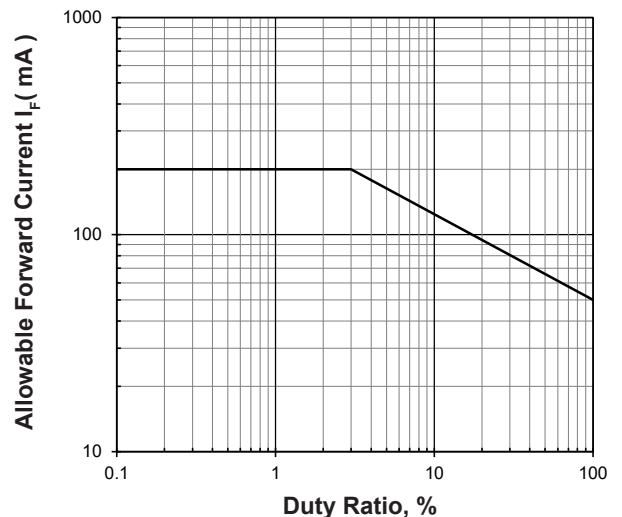
**Wavelength Shift Vs Forward Current**

$\lambda_{dom} = f(I_F); T_j = 25^\circ\text{C}$

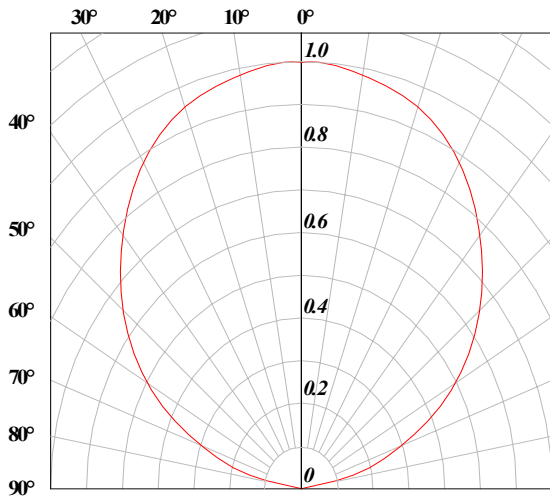


**Allowable Forward Current Vs Duty Ratio**

$(T_j = 55^\circ\text{C}; t_p \leq 100\mu\text{s}, D=0.03)$

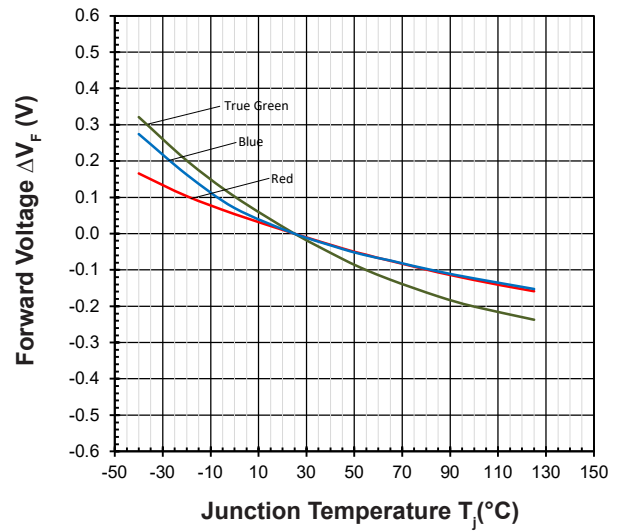


**Radiation Pattern**



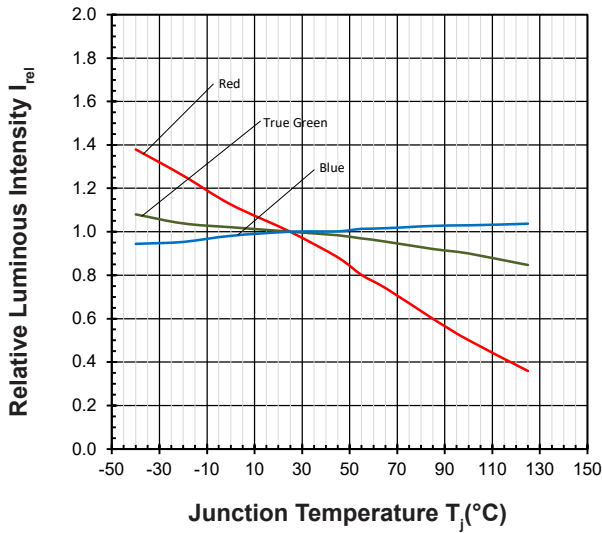
**Forward Voltage Vs Junction Temperature**

$$\Delta V_F = V_F - V_F(25^\circ\text{C}) = f(T_j); I_F = 20\text{mA}$$



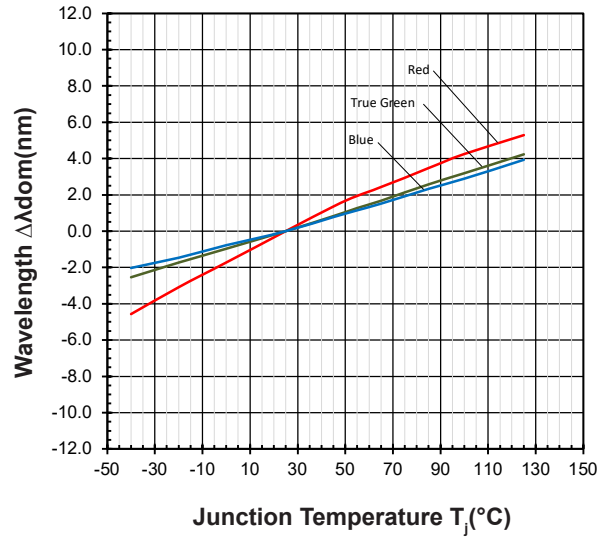
**Relative Luminous Intensity Vs Junction Temperature**

$$I_v/I_v(25^\circ\text{C}) = f(T_j); I_F = 20\text{mA}$$

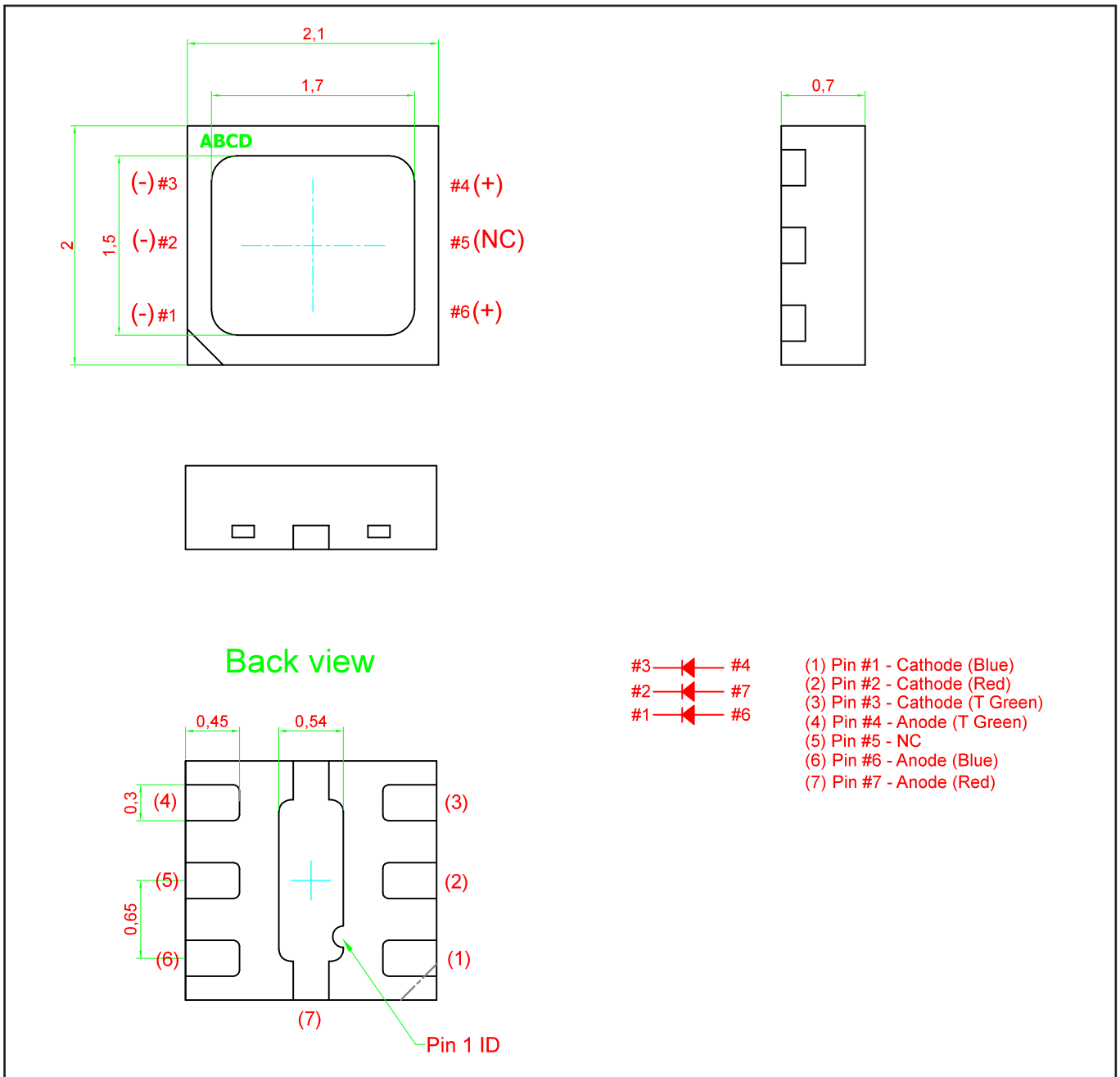


**Wavelength Vs Junction Temperature**

$$\Delta \lambda_{\text{dom}} = \lambda_{\text{dom}} - \lambda_{\text{dom}}(25^\circ\text{C}) = f(T_j); I_F = 20\text{mA}$$



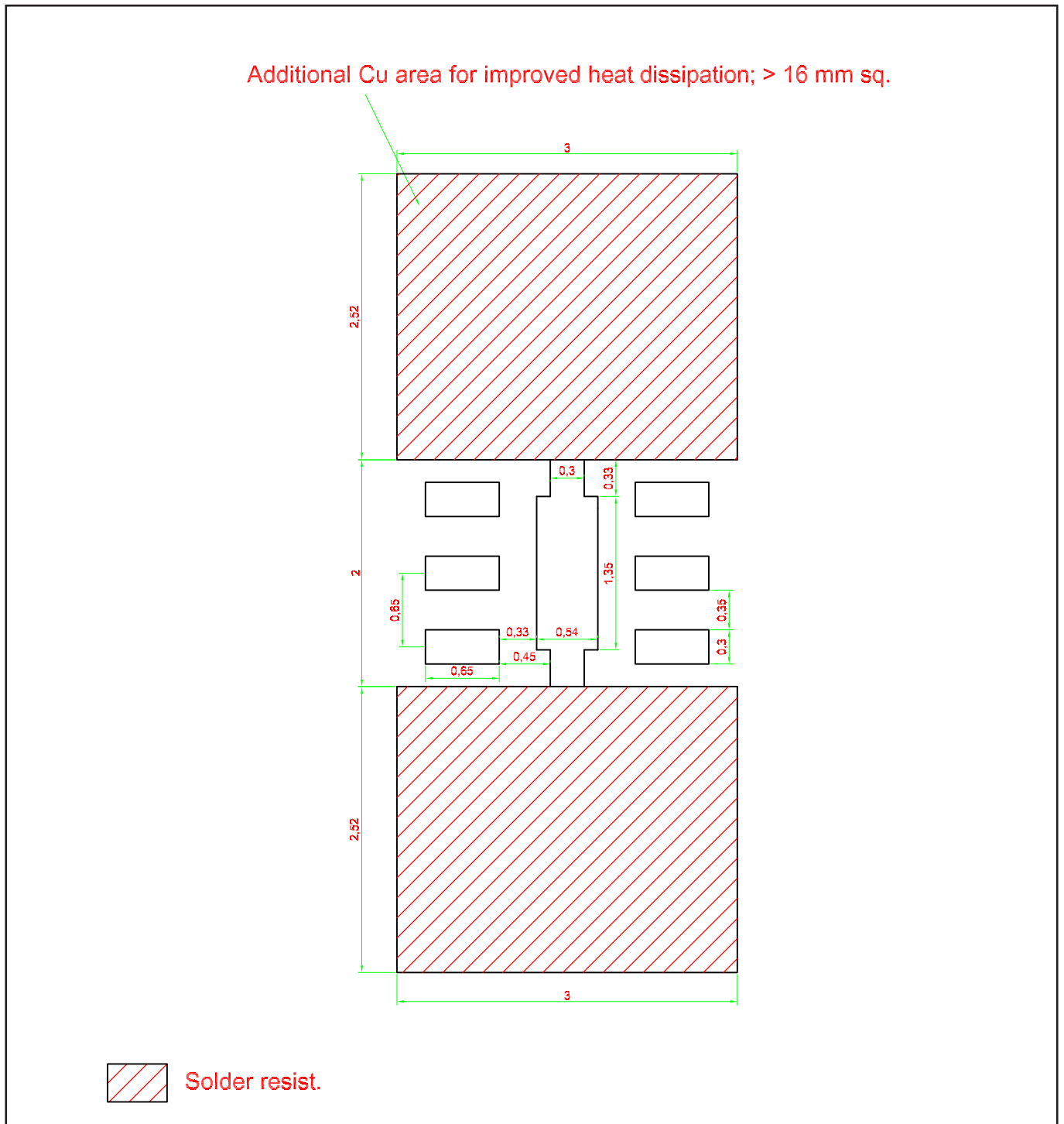
**SpicePlus 2120 Multi Color : SKRTB-MHG Package Outlines**



**Material**

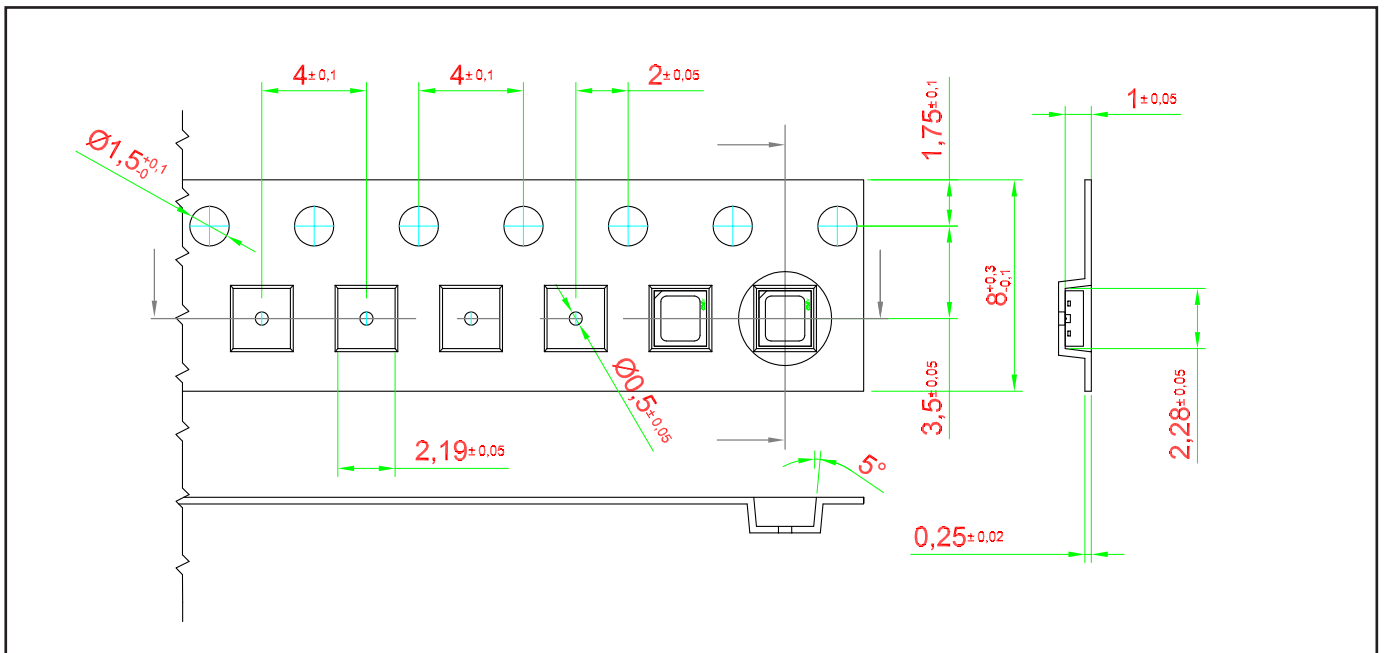
Material	
Lead-frame	Cu Alloy with Au Plating
Package	High Resistant Polymer
Encapsulant	Silicone Resin
Soldering Leads	Au Plating

**Recommended Solder Pad**

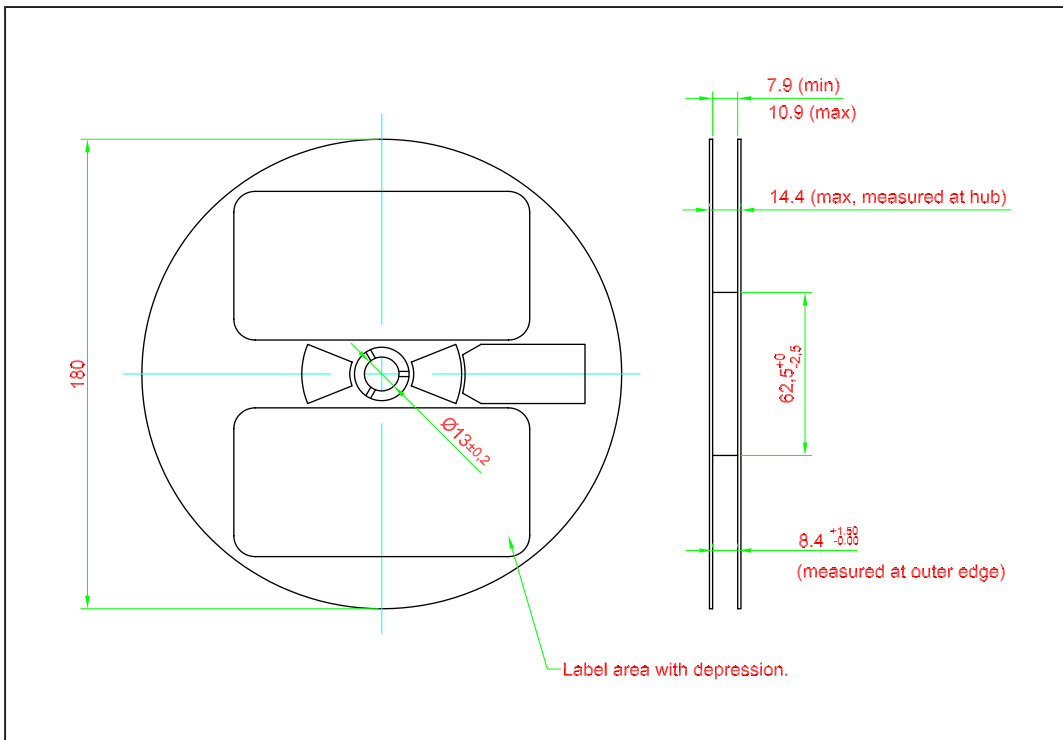




**Taping and orientation**



**Packaging Specification**

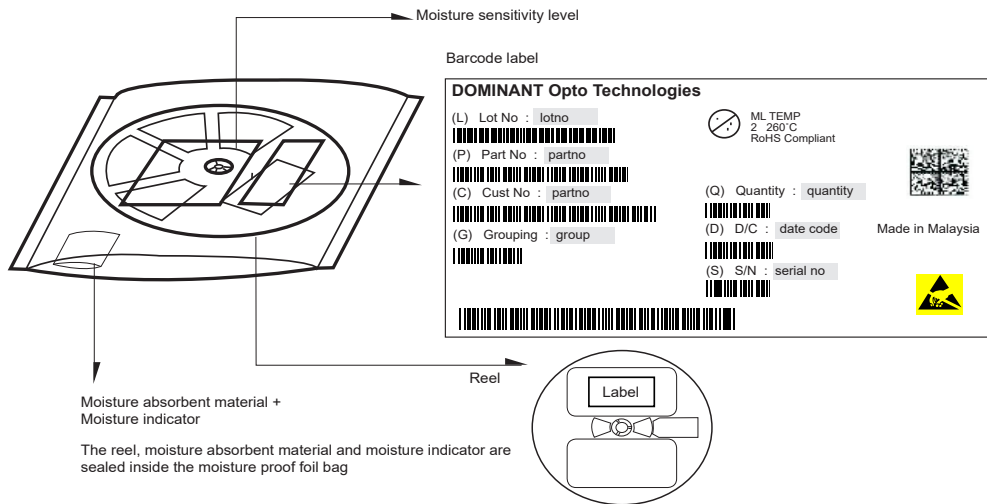


	Reel Diameter (mm)	Quantity (pcs)	*Ordering Number
Standard Packing	180	4000	SKRTB-MHG-xxx+xxx+xxx-1

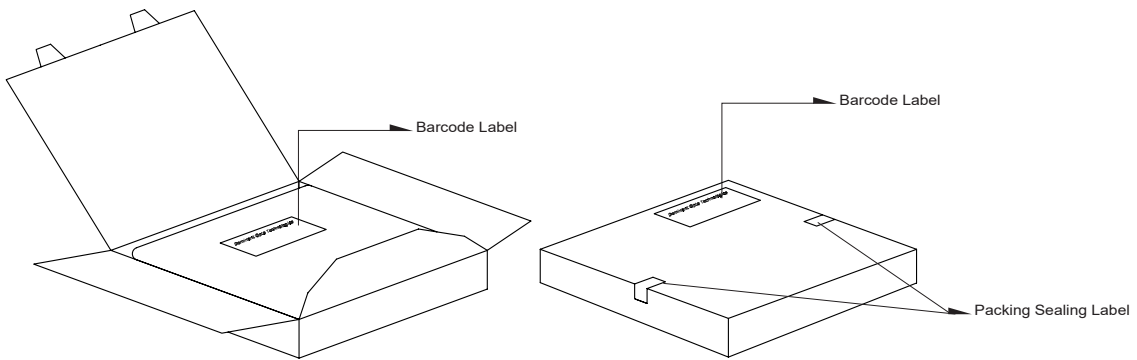
Notes:

\* For ordering purpose only. Please consult sales and marketing for details.

**Packaging Specification**



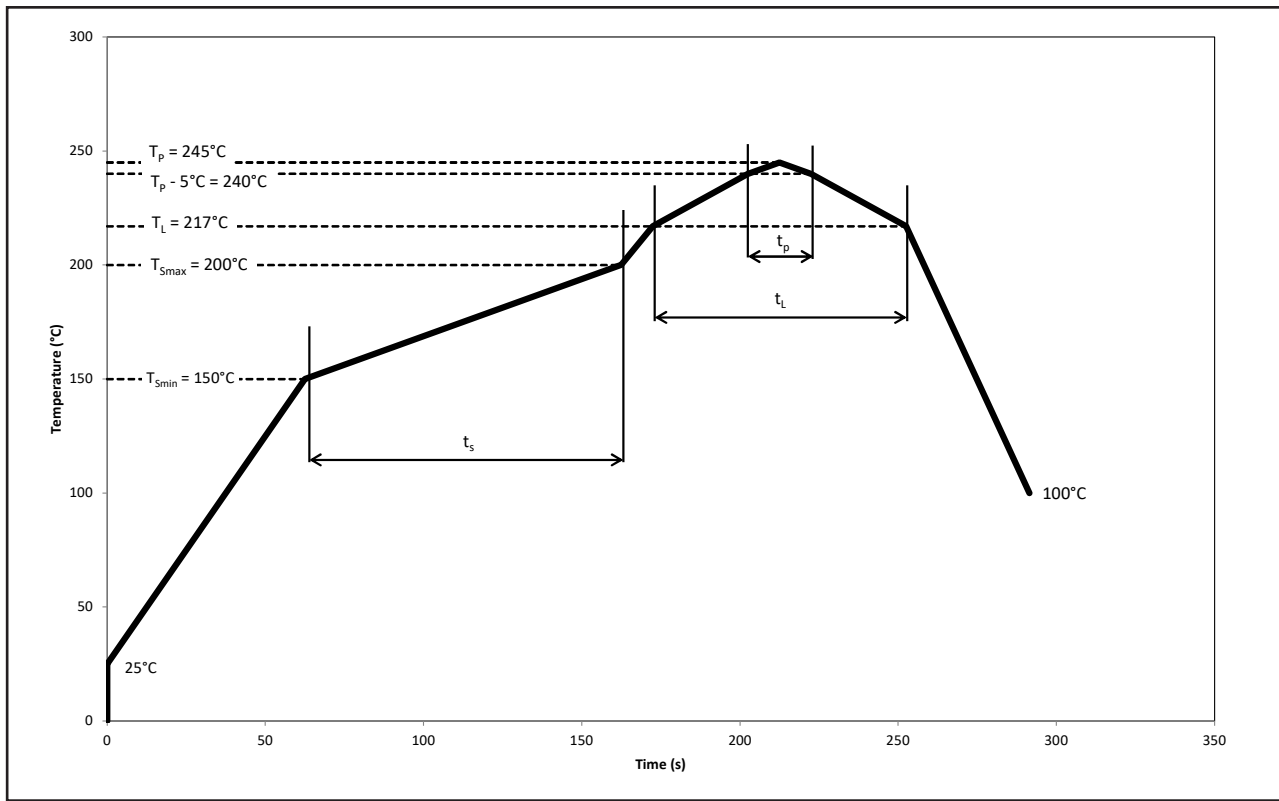
Quantity per bag (pcs)	Average 1pc SpicePlus RGB	1 completed bag (gram)
4000	0.008	220 ± 10



Reel Diameter (mm)	Packing Box Dimensions (mm)
180	210 x 210 x 16

## Recommended Pb-free Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



Profile Feature	Symbol	Pb-Free Assembly			Unit
		Min.	Recommended	Max.	
Ramp-up rate to preheat 25°C to $T_{smin}$	-	-	2	3	°C/s
Time $t_s$ $T_{smin}$ to $T_{smax}$	$t_s$	60	100	120	s
Ramp-up rate to peak $T_L$ to $T_p$	-	-	2	3	°C/s
Liquidous temperature	$T_L$	-	217	-	°C
Time above liquidous temperature	$t_L$	60	80	150	s
Peak temperature	$T_p$	-	245	260	°C
Time within 5°C of the specified peak temperature $T_p - 5^\circ\text{C}$	$t_p$	10	20	30	s
Ramp-down rate $T_p$ to 100°C	-	-	3	6	°C/s
Time 25°C to $T_p$	-	-	-	480	s

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## Appendix

### 1) **Brightness:**

- 1.1 Luminous intensity is measured at current pulse 25 ms(typ) with an internal reproducibility of  $\pm 8\%$  and an expanded uncertainty of  $\pm 11\%$  (according to GUM with a coverage factor of  $k=3$ ).
- 1.2 Luminous flux is measured at current pulse 25 ms(typ) with an internal reproducibility of  $\pm 8\%$  and an expanded uncertainty of  $\pm 11\%$  (according to GUM with a coverage factor of  $k=3$ ).
- 1.3 Radiant intensity is measured at current pulse 25 ms(typ) with an internal reproducibility of  $\pm 8\%$  and an expanded uncertainty of  $\pm 11\%$  (according to GUM with a coverage factor of  $k=3$ ).
- 1.4 Radiant flux is measured at current pulse 25 ms(typ) with an internal reproducibility of  $\pm 8\%$  and an expanded uncertainty of  $\pm 11\%$  (according to GUM with a coverage factor of  $k=3$ ).

### 2) **Color:**

- 2.1 Chromaticity coordinate groups are measured at current pulse 25 ms(typ) with an internal reproducibility of  $\pm 0.005$  and an expanded uncertainty of  $\pm 0.01$  (accordingly to GUM with a coverage factor of  $k=3$ ).
- 2.2 Dominant wavelength is measured at current pulse 25 ms(typ) with an internal reproducibility of  $\pm 0.5\text{nm}$  and an expanded uncertainty of  $\pm 1\text{nm}$  (accordingly to GUM with a coverage factor of  $k=3$ ).

### 3) **Voltage:**

- 3.1 Forward Voltage,  $V_f$  is measured when a current pulse of 8 ms(typ) with an internal reproducibility of  $\pm 0.05\text{V}$  and an expanded uncertainty of  $\pm 0.1\text{V}$  (accordingly to GUM with a coverage factor of  $k=3$ ).

### 4) **Typical Values:**

- 4.1 At special conditions of LED manufacturing processes, typical data or calculated correlations of technical parameters only reflect the statistical figures. But not necessarily correspond to the actual parameters of each single product, which could differ from the typical data or calculated correlations or the typical characteristic line. These typical data may change whenever technical improvements happen.

### 5) **Tolerance of Measure**

- 5.1 Unless otherwise noted in drawing, tolerances are specified with  $\pm 0.1$  and dimension are specific in mm.

### 6) **Reverse Voltage:**

- 6.1 Not designed for reverse operation. Continuous reverse voltage can cause migration and LED damage.

**Revision History**

Page	Subjects	Date of Modification
-	Initial Release	23 Dec 2022
2	Add New Part No SKRTB-MHG-V1V2+W4X4+R2S-1	19 May 2023

**NOTE**

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DOMINANT Opto Technologies is a dynamic company that is amongst the world's leading automotive LED manufacturers. With an extensive industry experience and relentless pursuit of innovation, DOMINANT's state-of-art manufacturing and development capabilities have become a trusted and reliable brand across the globe. More information about DOMINANT Opto Technologies, an IATF 16949 and ISO 14001 certified company, can be found under <http://www.dominant-semi.com>.

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